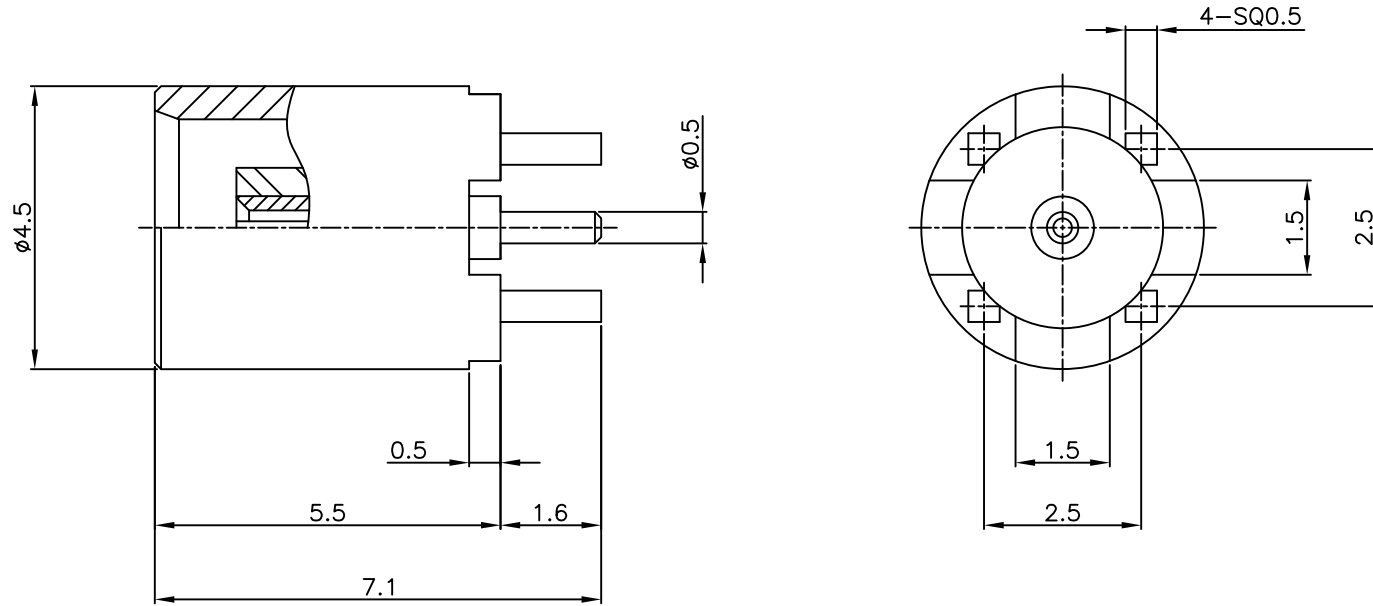
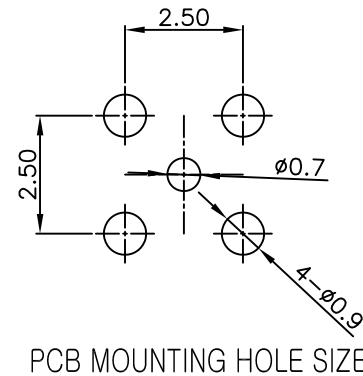


REVISION					
REV	DESCRIPTION		DRAWN	APPR	DATE
IR	Initial Registration		S.H.KIM		2022.07.06.
1	[설번No.202211-0006] 절연체 조립 후 돌출 방지로 인한 치수변경		S.Y.EUN	S.H.KIM	2022.11.03.



주 기.

- 주파수 범위 : DC~6GHz
- 전기적 특성
 - 특성 임피던스 : 50Ω
 - 절연저항 : 10,000MΩ 이상
 - 접촉저항 : 5.0mΩ 이하
 - D.W.V : AC 750Vrms 이상에서 1분간 견딜 것
- 온도 범위 : -55℃~+125℃
- 모든 덧살 및 날카로운 모서리를 제거할 것
- 모든 치수는 참고 치수임



3	INSULATOR	1	TEFLON		DIN03306-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT04317-5/1
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04840-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2022. 11. 03.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY	S.H.KIM			
MATERIAL		CHECKED BY	TITLE MCX50 PCB JS-4R			
		DRAWN BY				S.Y.EUN
FINISH		SCALE 8/1	UNIT mm		A4	DWG NO. CN04058-7/1
						REVISION 1